

5SLA 3600E170300

HiPak Single DIODE Module

 $V_{RRM} = 1700 \text{ V}$
 $I_F = 3600 \text{ A}$

Ultra low-loss, rugged SPT+ diode
 Smooth switching SPT+ diode for good EMC
 AISiC base-plate for high power cycling capability
 AlN substrate for low thermal resistance
 Improved high reliability package
 Recognized under UL1557, File E196689



Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	max	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25 \text{ }^{\circ}\text{C}$		1700	V
DC forward current	I_F			3600	A
Peak forward current	I_{FRM}	$t_p = 1 \text{ ms}$		7200	A
Total power dissipation	P_{tot}	$T_C = 25 \text{ }^{\circ}\text{C}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$		10300	W
Surge current	I_{FSM}	$V_R = 0 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$, $t_p = 10 \text{ ms}$, half-sinewave		18000	A
Isolation voltage	V_{isol}	1 min, $f = 50 \text{ Hz}$		4000	V
Junction temperature	T_{vj}			150	$^{\circ}\text{C}$
Junction operating temperature	$T_{vj(op)}$		-50	150	$^{\circ}\text{C}$
Case temperature	T_C		-50	150	$^{\circ}\text{C}$
Storage temperature	T_{stg}		-50	125	$^{\circ}\text{C}$
Mounting torques ²⁾	M_s	Base- heatsink, M6 screws	4	6	Nm
	M_{t1}	Main terminals, M8 screws	8	10	

¹⁾ Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747

²⁾ For detailed mounting instructions refer to Document No. 5SYA 2039

Diode characteristic values ³⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward voltage ⁴⁾	V _F	I _F = 3600 A	T _{vj} = 25 °C	1.85	2.2	V
			T _{vj} = 125 °C	1.95	2.3	V
			T _{vj} = 150 °C	1.9		V
Continuous reverse current	I _R	V _R = 1700 A	T _{vj} = 25 °C	0.02		mA
			T _{vj} = 125 °C	20	40	mA
			T _{vj} = 150 °C	70		mA
Reverse recovery current	I _{rr}	V _{CC} = 900 V, I _F = 3600 A, di/dt = 11.5 kA/μs L _σ = 50 nH, inductive load switch: 5SNA 3600E170300	T _{vj} = 25 °C	2030		A
			T _{vj} = 125 °C	2340		A
			T _{vj} = 150 °C	2500		A
Recovered charge	Q _{rr}		T _{vj} = 25 °C	1000		μC
			T _{vj} = 125 °C	1560		μC
			T _{vj} = 150 °C	1820		μC
Reverse recovery time	t _{rr}		T _{vj} = 25 °C	900		ns
			T _{vj} = 125 °C	1230		ns
			T _{vj} = 150 °C	1320		ns
Reverse recovery energy	E _{rec}		T _{vj} = 25 °C	710		mJ
			T _{vj} = 125 °C	1080		mJ
			T _{vj} = 150 °C	1260		mJ

³⁾ Characteristic values according to IEC 60747 – 2

⁴⁾ Forward voltage is given at chip level

Package properties ⁵⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Diode thermal resistance junction to case	$R_{th(j-c)DIODE}$				0.012	K/W
Diode thermal resistance ²⁾ case to heatsink	$R_{th(c-s)DIODE}$	Diode, λ grease = 1W/m x K		0.018		K/W
Comparative tracking index	CTI		600			
Module stray inductance	$L_\sigma AC$			8		nH
Resistance, terminal-chip	$R_{AA'+CC'}$	$T_C = 25\text{ °C}$		0.055		mΩ
		$T_C = 125\text{ °C}$		0.075		
		$T_C = 150\text{ °C}$		0.080		

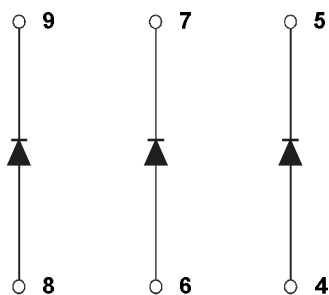
²⁾ For detailed mounting instructions refer to ABB Document No. 5SYA 2039

Mechanical properties ⁵⁾

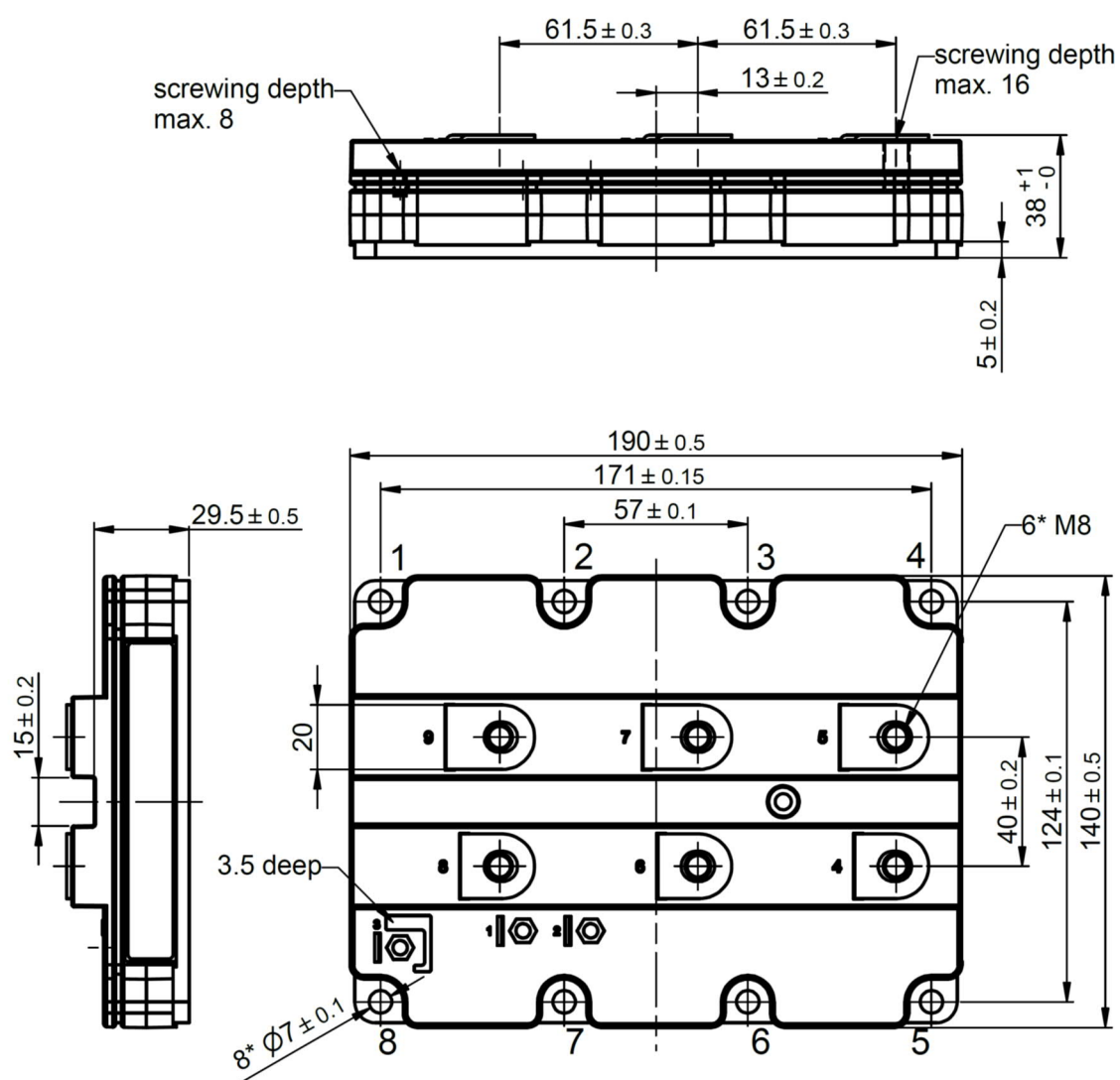
Parameter	Symbol	Conditions	min	typ	max	Unit
Dimensions	L x W x H	Typical	190 x 140 x 38			mm
Clearance distance in air	d_a	according to IEC 60664-1 and EN 50124-1	Term. to base:	23		mm
			Term. to term:	19		
Surface creepage distance	d_s	according to IEC 60664-1 and EN 50124-1	Term. to base:	28.2		mm
			Term. to term:	28.2		
Mass	m			1200		g

⁵⁾ Package and mechanical properties according to IEC 60747 – 15

Electrical configuration



Outline drawing ²⁾



Note: all dimensions are shown in millimeters

²⁾ For detailed mounting instructions refer to Document No. 5SYA 2039

This is an electrostatic sensitive device, please observe the international standard IEC 60747-1, chap. IX.
This product has been designed and qualified for Industrial Level.

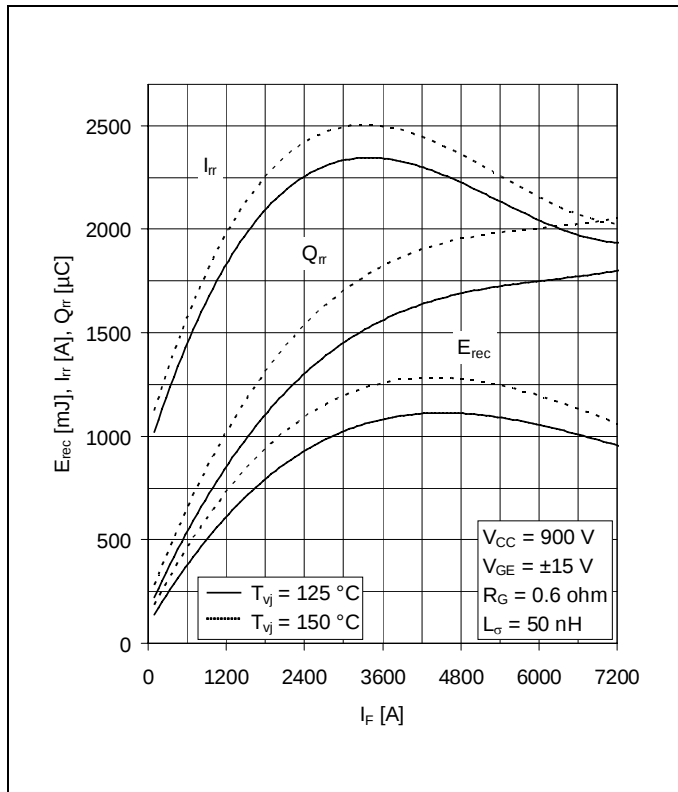


Fig. 1 Typical reverse recovery characteristics vs. forward current

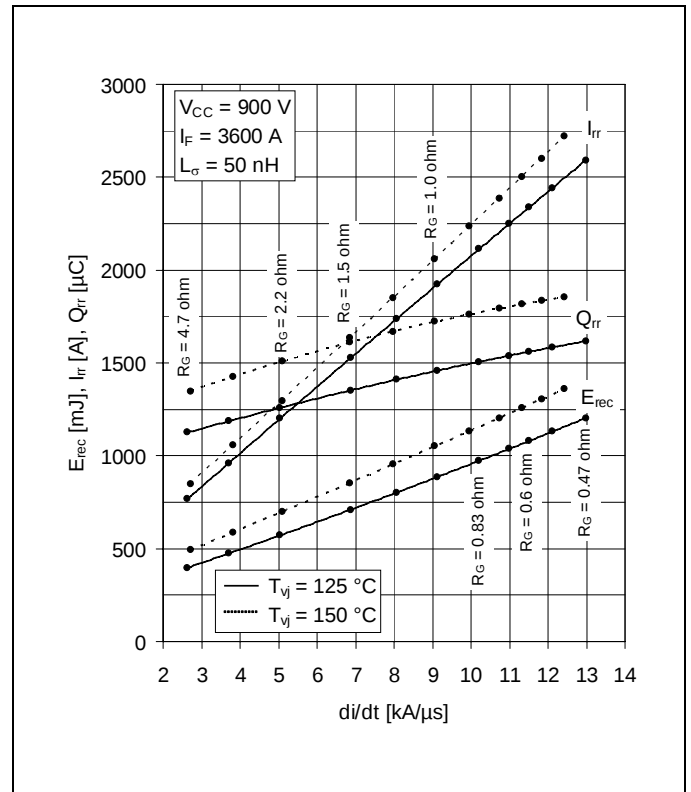


Fig. 2 Typical reverse recovery characteristics vs. di/dt

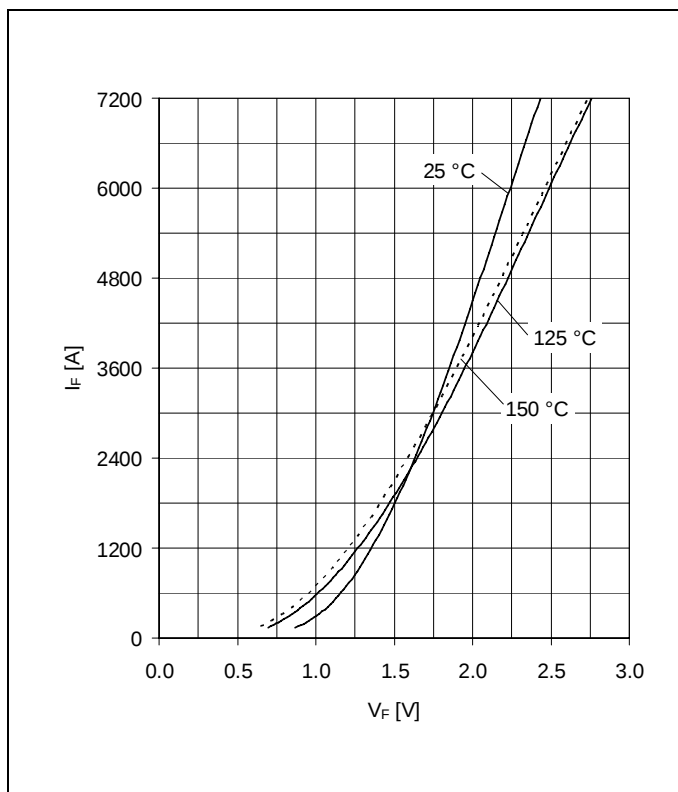


Fig. 3 Typical diode forward characteristics chip level

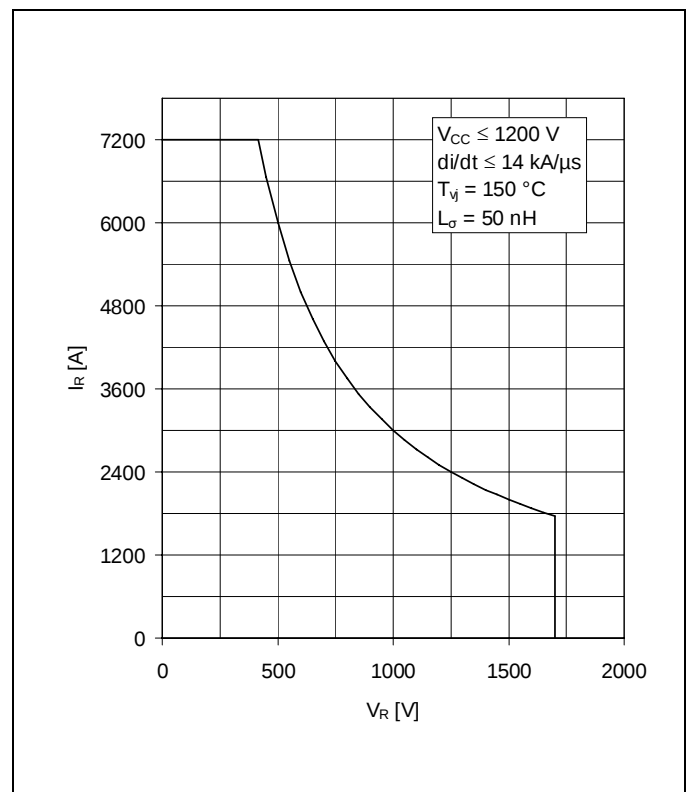


Fig. 4 Safe operating area diode (SOA)

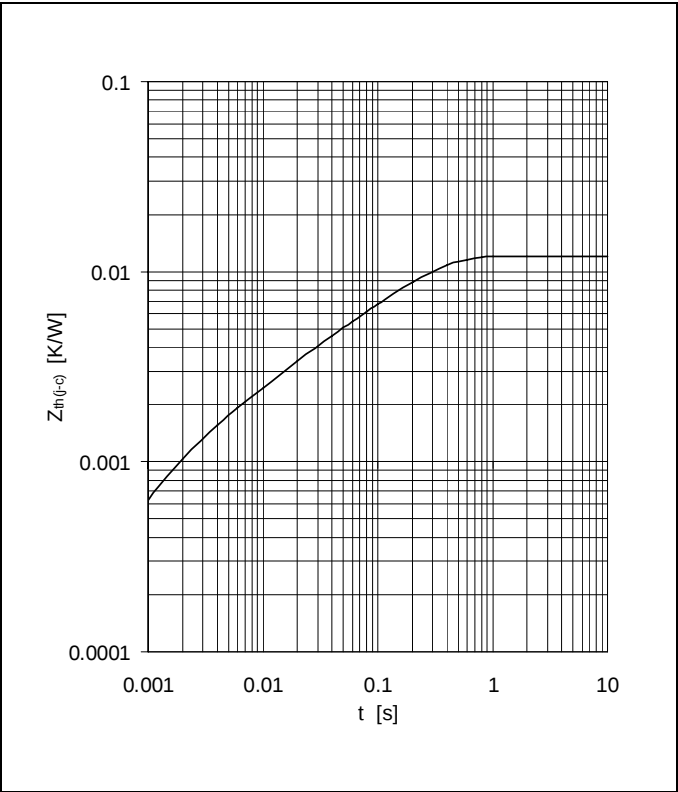


Fig. 5 Thermal impedance vs. time

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

DIODE	Ri(K/kW)	8.432	1.928	0.866	0.839	
	τi(ms)	210	29.6	7.01	1.49	

Related documents:

- 5SYA 2042 Failure rates of HiPak modules due to cosmic rays
- 5SYA 2043 Load – cycle capability of HiPaks
- 5SYA 2045 Thermal runaway during blocking
- 5SYA 2058 Surge currents for IGBT diodes
- 5SZK 9111 Specification of environmental class for HiPak Storage
- 5SZK 9112 Specification of environmental class for HiPak Transportation
- 5SZK 9113 Specification of environmental class for HiPak Operation (Industry)
- 5SZK 9120 Specification of environmental class for HiPak

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